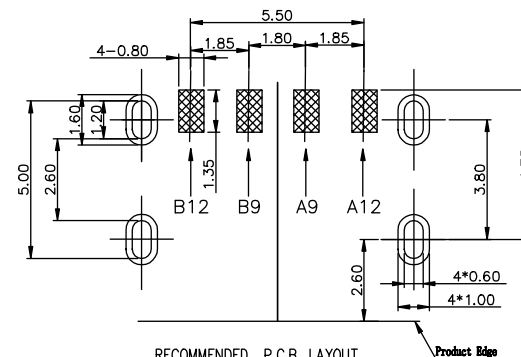
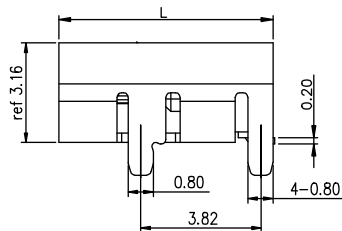
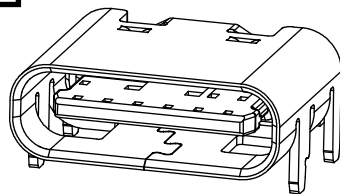
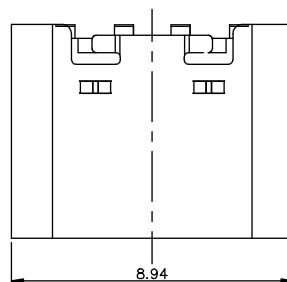
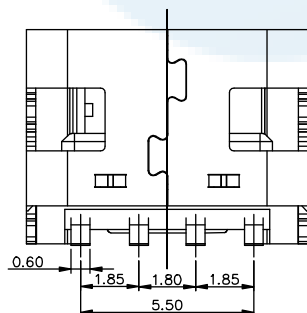
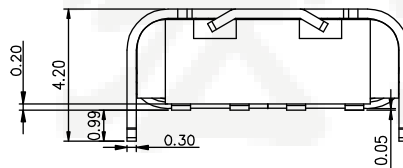
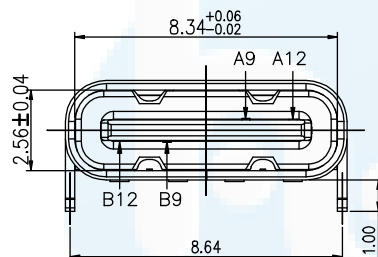


ROHS
Compatible



RECOMMENDED P.C.B. LAYOUT
TOLERANCE UNSPECIFIED $\pm 0.05\text{mm}$



NOTE:

1.MATERIAL SPECIFICATION:

- 1.HOUSING: HIGH TEMPERATURE RESISTANT PLASTIC, UL94 V-0.
- 2.CONTACTS: COPPER ALLOY
- 3.MID PLATE: STAINLESS STEEL
- 4.FRONT SHELL: STAINLESS STEEL

2.PLATING SPECIFICATION:

2-1.CONTACTS:

Ni 50u" MIN. UNDER PLATED OVER ALL.

Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.

(GOLD PLATING THICKNESS FOLLOW THE P/N)

PLATING SPECIFICATIONS OF THE SOLDER AREA FOLLOW THE P/N

2-2.FRONT SHELL:

SEE TABLE1.

2-3.SHIELD PLATE&EMI PLATE:

CLEAR ONLY

3.MECHANICAL PERFORMANCE,

3-1.INSERTION FORCE: 0.5~2.0kgf.

3-2.REMOVAL FORCE: 0.8kgf~2.0kgf.

3-3.DURABILITY: 5000 CYCLES.

4.ELECTRICAL PERFORMANCE,

4-1. CURRENT RATING: 3.0A

VOLTAGE RATING: 5.0V

4-2. LLCR:

VBUS & GND PINS AND OTHER PINS: 40mΩ/PIN MAX.

SHIELD: 50mΩ/MAX.

LLCR MAX. CHANGE OF ALL PINS: 10mΩ.

4-3.INSULATION RESISTANCE: 100MΩ MIN

4-4.DIELECTRIC WITHSTAND VOLTAGE, AC 100V FOR 1 MINUTE.

5. ENVIRONMENTAL PERFORMANCE:

OPERATING TEMPERATURE: -25°C~+85°C.

6.IR REFLOW:

THE PEAK TEMPERATURE ON THE BOARD SHALL
BE MAINTAINED FOR 10 SECONDS AT 260°C.

PIN ASSIGNMENTS

A9	VBUS	B12	GND		
A12	GND	B9	VBUS	L	L=6.5
PIN	SIGNAL NAME	PIN	SIGNAL NAME	L	L=6.8

DESIGN	Li Jinwei	SCALL	
DRAWING	Wu Qifa	UNIT	mm
CHECK	Zheng Jinxian	SIZE	A4: 210 * 297
APPROVAL	Liu Xiaohong	DATE	2020-06-10

	TOLERANCE
X.X ±0.30	X.°±2°
.XX ±0.20	.X°±1°
.XXX ±0.10	.XX°±0.5°

DRAWG NO.

TYPE-C-DS04P

TITLE:

4P 板上型四脚插板 SMT



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Dongguan hongyusheng Industry Co., Ltd
TEL: 0769-81230179 <https://www.hystypec.com>